## Abstract Submitted for the MAR16 Meeting of The American Physical Society

Investigation of the Magnetic Properties of Ni-implanted ITO Thin Films<sup>1</sup> FIGEN AY, BEKIR AKTAS, Gebze Technical University, Department of Physics, RUSTEM KHAIBULLIN, VLADIMIR NUZHDIN, Kazan Physical-Technical Institute of RAS, BULAT RAMEEV, Gebze Technical University, Department of Physics;Kazan Physical-Technical Institute of RAS — Commercially available ITO thin films on fused silica substrates were implanted with  $40 \text{ keV Ni}^+$ ions to fluences of  $(0.5, 1.0 \& 1.5) \times 10^{17}$  ions/cm<sup>2</sup> at room temperature. XRR measurements show that the thickness of the implanted films ( $\sim 28.5$  nm) does not change noticeably with the fluence, while the surface roughness increases essentially. SEM and EDX studies revealed a highly non-uniform distribution of Ni atoms. Room temperature ferromagnetism was observed in the samples with fluences of  $(1.0\&1.5)\times 10^{17}$  ions/cm<sup>2</sup>. VSM hysteresis curves and FMR signal point to the formation of a ferromagnetic near-surface layer in the implanted films due to agglomeration of closely-spaced metal Ni nanoparticles. The filling factor of the Ni ferromagnetic phase in the granular magnetic layer was estimated from the FMR results. Super- and para- magnetic phases were observed in the temperature dependence of magnetization by VSM. Superparamagnetic phase is attributed to the Ni nanoparticles located in deeper regions near the film/substrate interface, while paramagnetic phase is related to the impurity centers. For the samples with fluences of  $(1.0\&1.5) \times 10^{17}$  ions/cm<sup>2</sup> average sizes of the superparamagnetic nanoparticles were calculated from the blocking temperatures  $T_B$  observed in thermo-magnetic dependences.

<sup>1</sup>TÜBITAK, grant No. 114F359 TÜBITAK / RFBR joint project program, grant No. 213M524 / 14-02-91374-cT-a. RAS Programme No.32

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Date submitted: 11 Nov 2015

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